

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Leonard Forbes et al.

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

Docket No.: 1303.109US1

Serial No.: 10/623,788

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Examiner: Pamela E. Perkins

Group Art Unit: 2822

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

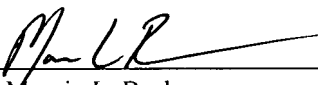
We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ Return postcard.
- ☒ Response Under 37 CFR 1.111 (20 pgs.).
- ☒ Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (2 pgs.), and copies of 21 cited documents.
- ☒ Authorization to charge Deposit Account 19-0743 in the amount of \$180.00 to cover the fee for consideration of Information Disclosure Statement under 97(c).


If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.

Customer Number 21186

By: 
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 9 day of November, 2007.


Name


Signature

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.

(GENERAL)